General-purpose Schottky diodes

Rev. 9 — 18 March 2015

Product data sheet

1. Product profile

1.1 General description

General-purpose Schottky diodes in small Surface-Mounted Device (SMD) plastic packages.

Type number	Package		Configuration
	NXP	JEITA	
1PS70SB40	SOT323	SC-70	single diode
1PS76SB40	SOD323	SC-76	single diode
1PS79SB40	SOD523	SC-79	single diode
BAS40	SOT23	-	single diode
BAS40H	SOD123F	-	single diode
BAS40L	SOD882	-	single diode
BAS40W	SOT323	SC-70	single diode
1PS70SB44	SOT323	SC-70	dual series
BAS40-04	SOT23	-	dual series
BAS40-04W	SOT323	SC-70	dual series
1PS70SB45	SOT323	SC-70	dual common cathode
1PS75SB45	SOT416	SC-75	dual common cathode
BAS40-05	SOT23	-	dual common cathode
BAS40-05W	SOT323	SC-70	dual common cathode
1PS70SB46	SOT323	SC-70	dual common anode
BAS40-06	SOT23	-	dual common anode
BAS40-06W	SOT323	SC-70	dual common anode
BAS40-07	SOT143B	-	dual isolated
BAS40-07V	SOT666	-	dual isolated
BAS40-05V	SOT666	-	quadruple common cathode/ common cathode
1PS88SB48	SOT363	SC-88	quadruple common cathode/ common cathode
BAS40XY	SOT363	SC-88	quadruple; 2 series

Table 1. Product overview



General-purpose Schottky diodes

1.2 Features and benefits

- High switching speed
- High breakdown voltage
- AEC-Q101 qualified

1.3 Applications

Ultra high-speed switching

Low leakage current

- Low capacitance
- Voltage clamping

1.4 Quick reference data

Symbol	Parameter	Conditions	Conditions I		Тур	Max	Unit
Per diode							
I _F	forward current			-	-	120	mA
V _F	forward voltage	I _F = 1 mA	[1]	-	-	380	mV
V _R	reverse voltage			-	-	40	V

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2. Pinning information

Pin	Description	Simplified outline	e Symbol
BAS40H;	1PS76SB40; 1PS79SB40		
1	cathode	[1]	
2	anode	1 001aab540	1 <u>-</u> 2 2 sym001
BAS40L			
1	cathode	[1]	
2	anode	1 2 Transparent top view	1 <u>₩</u> 2 sym001
BAS40; E	3AS40W; 1PS70SB40		
1	anode		
2	not connected	3	
3	cathode	12	1 2

General-purpose Schottky diodes

Table 3. Pi	nningcontinued		
Pin	Description	Simplified outline	Symbol
BAS40-04; BA	AS40-04W; 1PS70SB44		
1	anode (diode 1)		-
2	cathode (diode 2)	3	3
3	cathode (diode 1),		1 2
	anode (diode 2)		006aaa437
		1 2	
		006aaa144	
BAS40-05; BA	AS40-05W; 1PS70SB45; 1PS75SB45		
1	anode (diode 1)		3
2	anode (diode 2)	3	
3	cathode (diode 1),		
	cathode (diode 2)		
		1 2	1 2
		006aaa144	006aaa438
BAS40-06; B/	AS40-06W; 1PS70SB46	1	
1	cathode (diode 1)		3
2	cathode (diode 2)	3	
3	anode (diode 1), anode (diode 2)		1 - 1
			006aaa439
		1 2	
		006aaa144	
BAS40-07		1	
1	cathode (diode 1)	4 3	4 3
2	cathode (diode 2)	<u> </u>	
3	anode (diode 2)	_	
4	anode (diode 1)		
		1 2	006aaa434
BAS40-07V	<u> </u>	1	1
1	anode (diode 1)		
2	not connected		
3	cathode (diode 2)		☆ ' ☆
4	anode (diode 2)		
5	not connected		1 2 3 <i>006aaa440</i>
6	cathode (diode 1)	123	

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Pin	Description	Simplified outline	Symbol		
BAS40-05	5V; 1PS88SB48				
1	anode (diode 1)				
2	anode (diode 2)	6 5 4			
3	cathode (diode 3), cathode (diode 4)				
4	anode (diode 3)	0			
5	anode (diode 4)	1 2 3 001aab555			
6	cathode (diode 1), cathode (diode 2)		<i>006aaa446</i>		
BAS40XY	,				
1	anode (diode 1)				
2	cathode (diode 2)				
3	anode (diode 3), cathode (diode 4)	0			
4	anode (diode 4)				
5	cathode (diode 3)				
6	cathode (diode 1), anode (diode 2)		1 2 3 006aaa256		

[1] The marking bar indicates the cathode.

General-purpose Schottky diodes

3. Ordering information

Table 4. Orde	ering inform	nation	
Type number	Package		
	Name	Description	Version
1PS70SB40	SC-70	plastic surface-mounted package; 3 leads	SOT323
1PS76SB40	SC-76	plastic surface-mounted package; 2 leads	SOD323
1PS79SB40	SC-79	plastic surface-mounted package; 2 leads	SOD523
BAS40	-	plastic surface-mounted package; 3 leads	SOT23
BAS40H	-	plastic surface-mounted package; 2 leads	SOD123F
BAS40L	-	leadless ultra small plastic package; 2 terminals; body 1.0 \times 0.6 \times 0.5 mm	SOD882
BAS40W	SC-70	plastic surface-mounted package; 3 leads	SOT323
1PS70SB44	SC-70	plastic surface-mounted package; 3 leads	SOT323
BAS40-04	-	plastic surface-mounted package; 3 leads	SOT23
BAS40-04W	SC-70	plastic surface-mounted package; 3 leads	SOT323
1PS70SB45	SC-70	plastic surface-mounted package; 3 leads	SOT323
1PS75SB45	SC-75	plastic surface-mounted package; 3 leads	SOT416
BAS40-05	-	plastic surface-mounted package; 3 leads	SOT23
BAS40-05W	SC-70	plastic surface-mounted package; 3 leads	SOT323
1PS70SB46	SC-70	plastic surface-mounted package; 3 leads	SOT323
BAS40-06	-	plastic surface-mounted package; 3 leads	SOT23
BAS40-06W	SC-70	plastic surface-mounted package; 3 leads	SOT323
BAS40-07	-	plastic surface-mounted package; 4 leads	SOT143B
BAS40-07V	-	plastic surface-mounted package; 6 leads	SOT666
BAS40-05V	-	plastic surface-mounted package; 6 leads	SOT666
1PS88SB48	SC-88	plastic surface-mounted package; 6 leads	SOT363
BAS40XY	SC-88	plastic surface-mounted package; 6 leads	SOT363

General-purpose Schottky diodes

4. Marking

Table 5. Marking codes							
Type number	Marking code ^[1]	Type number	Marking code ^[1]				
1PS70SB40	6*3	1PS75SB45	45				
1PS76SB40	S4	BAS40-05	45*				
1PS79SB40	Т	BAS40-05W	65*				
BAS40	43*	1PS70SB46	6*6				
BAS40H	AJ	BAS40-06	46*				
BAS40L	S6	BAS40-06W	66*				
BAS40W	63*	BAS40-07	47*				
1PS70SB44	6*4	BAS40-07V	67				
BAS40-04	44*	BAS40-05V	65				
BAS40-04W	64*	1PS88SB48	8*5				
1PS70SB45	6*5	BAS40XY	40*				

[1] * = -: made in Hong Kong

* = p: made in Hong Kong

* = t: made in Malaysia

* = W: made in China

5. Limiting values

Table 6. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
Per diode				I	I
V _R	reverse voltage		-	40	V
l _F	forward current		-	120	mA
I _{FRM}	repetitive peak forward $t_p \leq 1 \ s; \ \delta \leq 0.5$ current		-	120	mA
I _{FSM}	non-repetitive peak forward current	$t_p \le 10 \text{ ms}$	<u>[1]</u> -	200	mA
Tj	junction temperature		-	150	°C
T _{amb}	ambient temperature		-65	+150	°C
T _{stg}	storage temperature		-65	+150	°C

[1] $T_j = 25 \circ C$ prior to surge.

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6. Thermal characteristics

Symbol	Parameter	Parameter Conditions M		Min	Тур	Max	Unit
Per devic	e						
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	<u>[1]</u>				
	SOT23			-	-	500	K/W
	SOT143B			-	-	500	K/W
	SOT363 (1PS88SB48)			-	-	416	K/W
	SOT416			-	-	833	K/W
	SOT666 (BAS40-05V)		[2]	-	-	225	K/W
	SOT666 (BAS40-07V)		[2]	-	-	416	K/W
	SOD123F		[2]	-	-	330	K/W
	SOD323			-	-	450	K/W
	SOD523		[2]	-	-	450	K/W
	SOD882		[2]	-	-	500	K/W
	SOT323			-	-	625	K/W
R _{th(j-sp)}	thermal resistance from junction to solder point						
	SOT363 (BAS40XY)		[3]	-	-	260	K/W

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

[2] Reflow soldering is the only recommended soldering method.

[3] Soldering point at pins 2, 3, 5 and 6.

7. Characteristics

Table 8.Characteristics

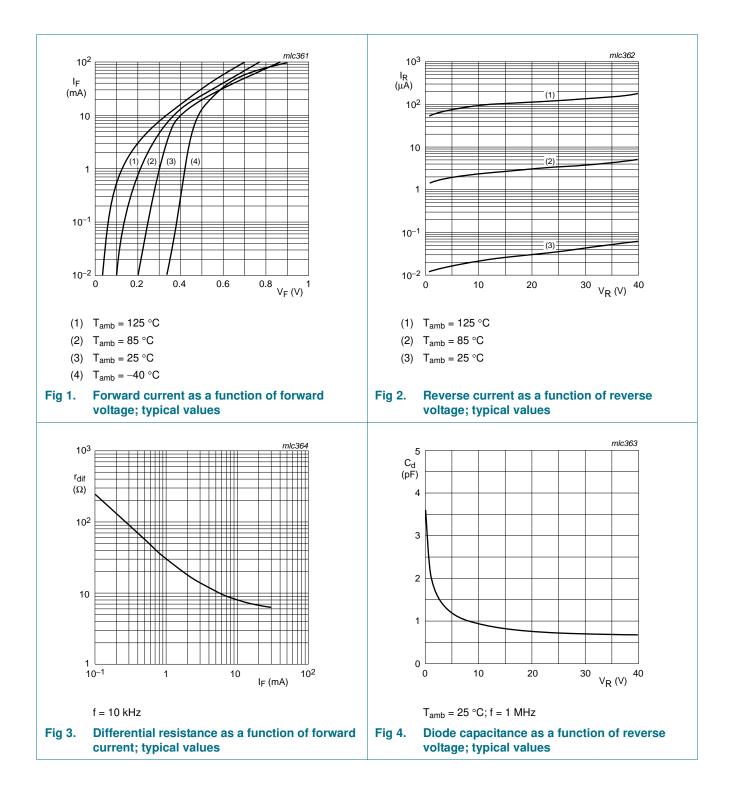
T_{amb} = 25 °C unless otherwise specified.

umo									
Symbol	Parameter	Conditions		Min	Тур	Max	Unit		
Per diode									
V _F	forward voltage		[1]						
		I _F = 1 mA		-	-	380	mV		
		I _F = 10 mA		-	-	500	mV		
		$I_F = 40 \text{ mA}$		-	-	1	V		
I _R	reverse current	V _R = 30 V		-	-	1	μA		
		V _R = 40 V		-	-	10	μA		
C _d	diode capacitance	V _R = 0 V; f = 1 MHz		-	-	5	pF		

NXP Semiconductors

BAS40 series; 1PSxxSB4x series

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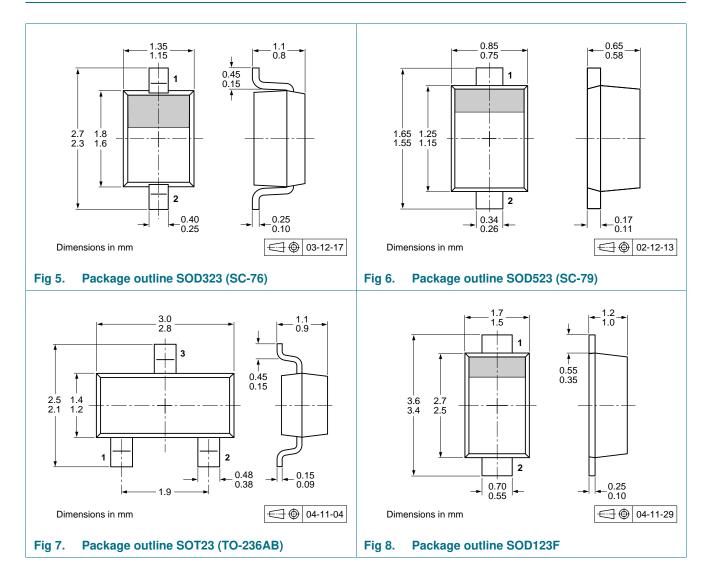
General-purpose Schottky diodes

8. Test information

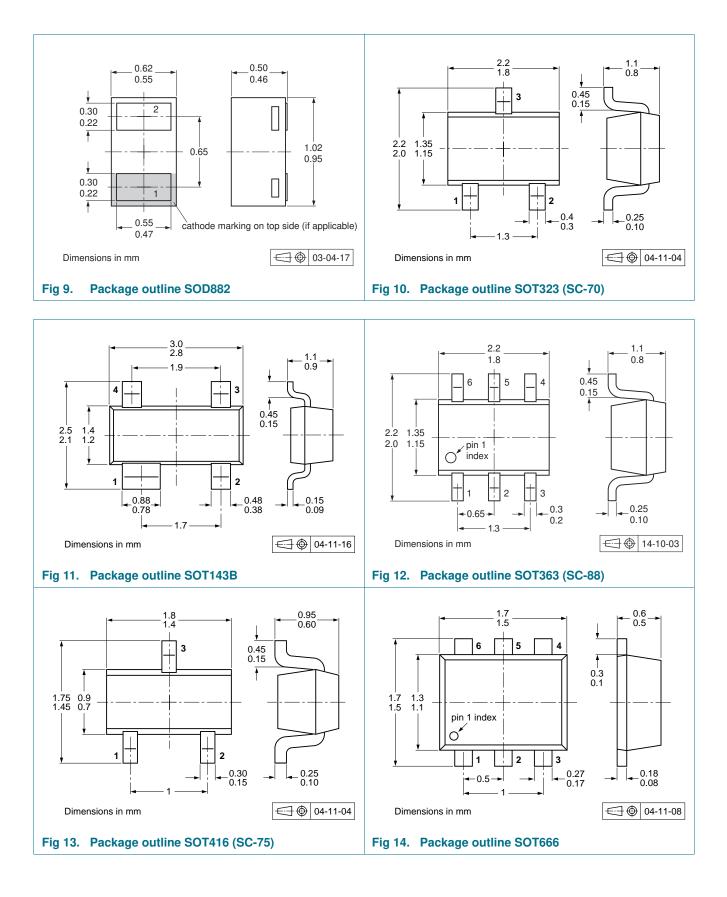
8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101* - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

9. Package outline



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10. Packing information

Table 9. Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code.[1]

Type number	Package	Description		Packing quantity				
				3000	4000	8000	10000	
1PS70SB40	SOT323	4 mm pitch, 8 mm tape and reel		-115	-	-	-135	
1PS76SB40	SOD323	4 mm pitch, 8 mm tape and reel		-115	-	-	-135	
1PS79SB40	SOD523	2 mm pitch, 8 mm tape and reel		-	-	-315	-	
		4 mm pitch, 8 mm tape and reel		-115	-	-	-135	
BAS40	SOT23	4 mm pitch, 8 mm tape and reel		-215	-	-	-235	
BAS40H	SOD123F	4 mm pitch, 8 mm tape and reel		-115	-	-	-135	
BAS40L	SOD882	2 mm pitch, 8 mm tape and reel		-	-	-	-315	
BAS40W	SOT323	4 mm pitch, 8 mm tape and reel		-115	-	-	-135	
1PS70SB44	SOT323	4 mm pitch, 8 mm tape and reel		-115	-	-	-135	
BAS40-04	SOT23	4 mm pitch, 8 mm tape and reel		-215	-	-	-235	
BAS40-04W	SOT323	4 mm pitch, 8 mm tape and reel		-115	-	-	-135	
1PS70SB45	SOT323	4 mm pitch, 8 mm tape and reel		-115	-	-	-135	
1PS75SB45	SOT416	4 mm pitch, 8 mm tape and reel		-115	-	-	-135	
BAS40-05	SOT23	4 mm pitch, 8 mm tape and reel		-215	-	-	-235	
BAS40-05W	SOT323	4 mm pitch, 8 mm tape and reel		-115	-	-	-135	
1PS70SB46	SOT323	4 mm pitch, 8 mm tape and reel		-115	-	-	-135	
BAS40-06	SOT23	4 mm pitch, 8 mm tape and reel		-215	-	-	-235	
BAS40-06W	SOT323	4 mm pitch, 8 mm tape and reel		-115	-	-	-135	
BAS40-07	SOT143B	4 mm pitch, 8 mm tape and reel		-215	-	-	-235	
BAS40-07V	SOT666	2 mm pitch, 8 mm tape and reel		-	-	-315	-	
		4 mm pitch, 8 mm tape and reel		-	-115	-	-	
BAS40-05V	SOT666	2 mm pitch, 8 mm tape and reel		-	-	-315	-	
		4 mm pitch, 8 mm tape and reel		-	-115	-	-	
1PS88SB48	SOT363	4 mm pitch, 8 mm tape and reel; T1	[2]	-115	-	-	-135	
		4 mm pitch, 8 mm tape and reel; T2	[3]	-125	-	-	-165	
BAS40XY	SOT363	4 mm pitch, 8 mm tape and reel; T1	[2]	-115	-	-	-135	
		4 mm pitch, 8 mm tape and reel; T2	[3]	-125	-	-	-165	

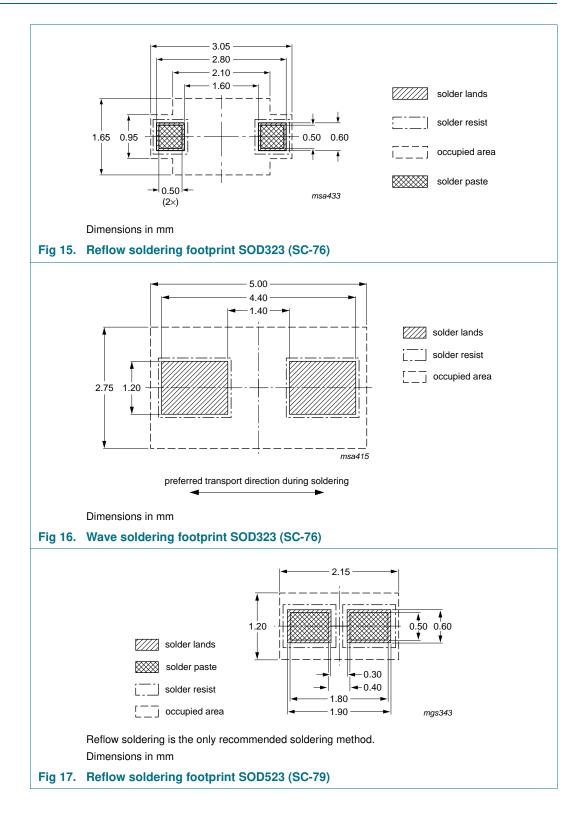
[1] For further information and the availability of packing methods, see Section 14.

[2] T1: normal taping

[3] T2: reverse taping

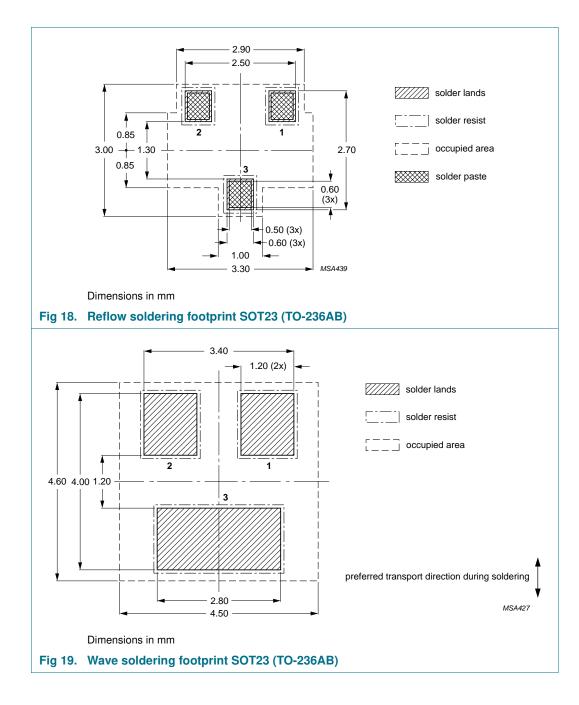
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11. Soldering

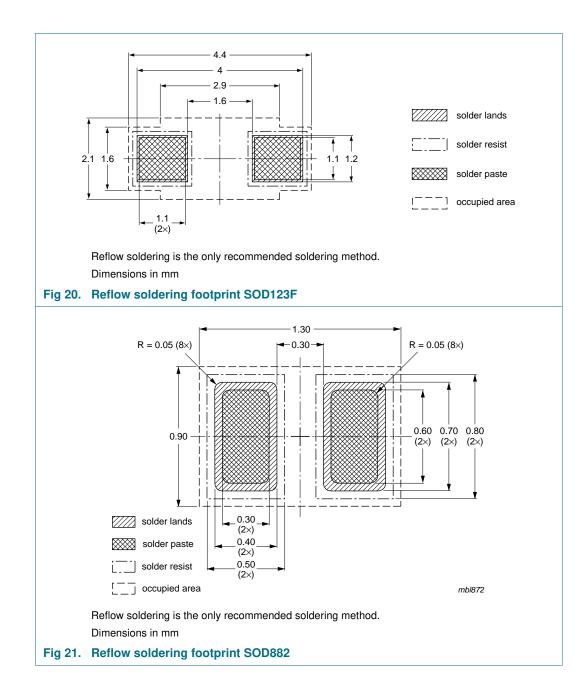


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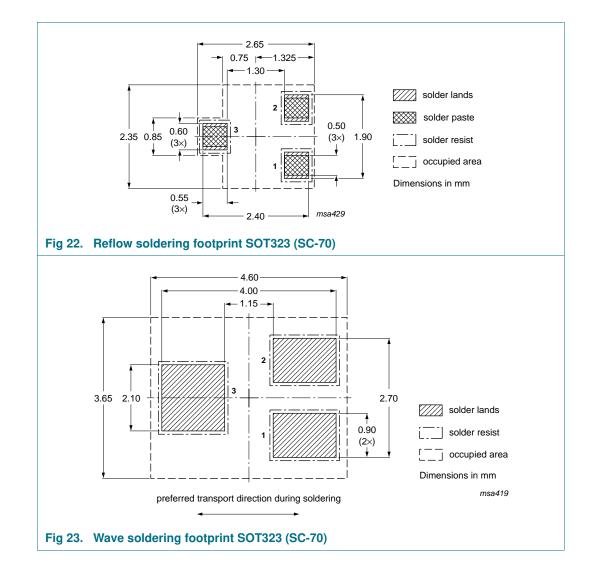
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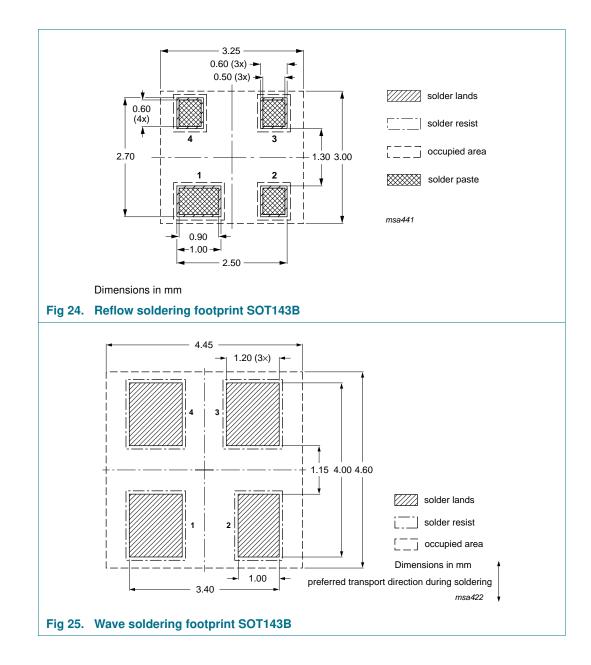
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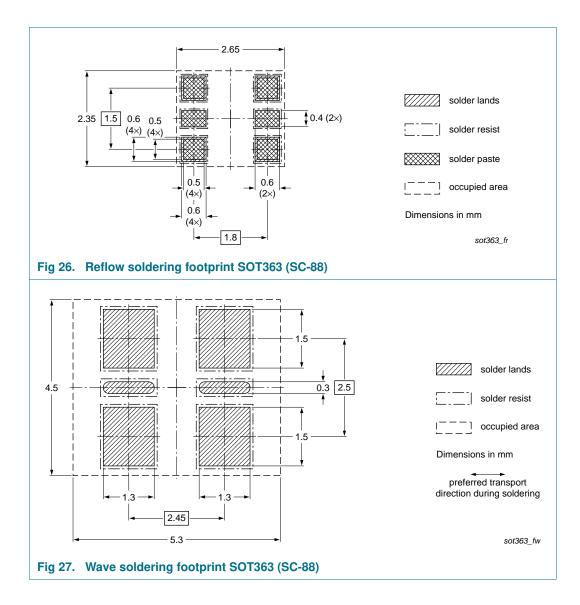
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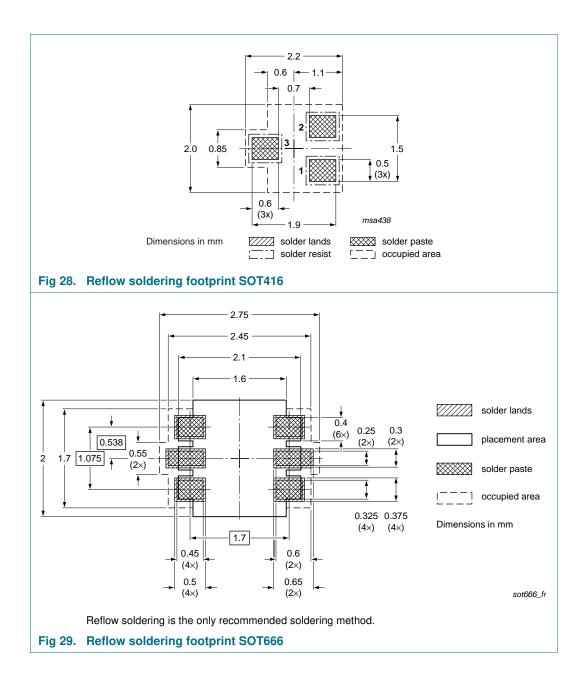
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12. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BAS40_1PSXXSB4X_SER v.9	20150318	Product data sheet	-	BAS40_1PSXXSB4X_SER_8
Modifications:		of this data sheet has bee f NXP Semiconductors.	en redesigned to co	omply with the new identity
	 Legal texts h 	have been adapted to the	e new company na	me where appropriate.
BAS40_1PSXXSB4X_SER_8	20100113	Product data sheet	-	BAS40_1PSXXSB4X_SER_7
BAS40_1PSXXSB4X_SER_7	20060512	Product data sheet	-	BAS40_1PSXXSB4X_SER_6
BAS40_1PSXXSB4X_SER_6	20050809	Product data sheet	-	1PS70SB40_3 1PS75SB45_2 1PS76SB40_3 1PS79SB40_2 1PS88SB48_3 BAS40H_1 BAS40L_1 BAS40-05V_1 BAS40-07V_1 BAS40W_3 BAS40_SERIES_5
1PS70SB40_3	19990426	Product specification	-	1PS70SB40_2
1PS75SB45_2	19990426	Product specification	-	1PS75SB45_1
1PS76SB40_3	20040126	Product specification	-	1PS76SB40_2
1PS79SB40_2	19990426	Product specification	-	1PS79SB40_1
1PS88SB48_3	20021107	Product specification	-	1PS88SB48_2
BAS40H_1	20050425	Product data sheet	-	-
BAS40L_1	20030520	Product specification	-	-
BAS40-05V_1	20021121	Product specification	-	-
BAS40-07V_1	20020327	Product specification	-	-
BAS40W_3	19990426	Product specification	-	BAS40W_2
BAS40_SERIES_5	20011010	Product specification	-	BAS40_4

13. Legal information

13.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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Date of release: 18 March 2015 Document identifier: BAS40_1PSXXSB4X_SER